**Philips Semiconductors** 

**Product specification** 

# Rectifier diodes ultrafast, rugged

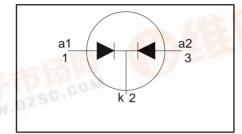
# **BYQ30EX** series

#### **FEATURES**

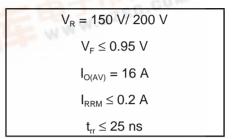
- Low forward volt drop
- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
- Isolated mounting tab

# **SYMBOL**

WWW.DZSC



#### QUICK REFERENCE DATA



#### **GENERAL DESCRIPTION**

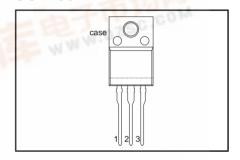
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYQ30EX series is supplied in the conventional leaded SOT186A package.

#### **PINNING**

PIN	DESCRIPTION		
1	anode 1		
2	cathode		
3	anode 2		
tab	isolated		

# SOT186A



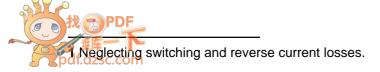
# LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	M.	λX.	UNIT
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	Peak repetitive reverse voltage Crest working reverse voltage Continuous reverse voltage	BYQ30EX		<b>-150</b> 150 150 150	<b>-200</b> 200 200 200	V V V
I <sub>O(AV)</sub>	Average rectified output current (both diodes conducting) <sup>1</sup>	$\delta = 0.5$ ; $T_{hs} \le 59$ °C	-	-	6	Α
I <sub>FRM</sub>	Repetitive peak forward current per diode	T <sub>hs</sub> ≤ 59 °C	-	-	6	A
I <sub>FSM</sub>	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-		00	A A
I <sub>RRM</sub>	Repetitive peak reverse current per diode	$V_{\text{RWM(max)}}$ $t_p = 2 \ \mu \text{s}; \ \delta = 0.001$	Tie	W W W O	.2	А
I <sub>RSM</sub>	Non-repetitive peak reverse current per diode	t <sub>p</sub> = 100 μs	-	0	.2	Α
$egin{array}{c} T_{stg} \ T_{j} \end{array}$	Storage temperature Operating junction temperature	COM	-40 -		50 50	O, C

## **ESD LIMITING VALUE**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>C</sub>	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 kΩ	-	8	kV



Rectifier diodes ultrafast, rugged

BYQ30EX series

# **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs}$  = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>isol</sub>	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-		2500	V
C <sub>isol</sub>	Capacitance from T2 to external heatsink	f = 1 MHz	-	10	-	pF

# THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th j-hs}}$ $R_{\text{th j-a}}$	heatsink	with heatsink compound without heatsink compound in free air		- - 55	5.0 7.0 -	K/W K/W K/W

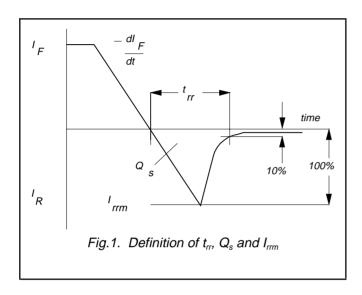
# **ELECTRICAL CHARACTERISTICS**

characteristics are per diode at T<sub>i</sub> = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	$I_F = 8 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.83	0.95	V
		$I_{\rm F} = 16  \text{A};  T_{\rm i} = 150  ^{\circ} \text{C}$	-	1.0	1.15	V
		$I_{\rm F} = 16  \text{A};$	-	0.98	1.25	
I <sub>R</sub>	Reverse current	$V_R = V_{RWM}$ ; $T_i = 100 ^{\circ}C$	-	0.3	0.6	mA
		$V_R = V_{RWM}$	-	2	30	μA nC
$Q_{\rm s}$	Reverse recovery charge	$ I _{E} = 2 \text{ A}$ : $V_{D} \ge 30 \text{ V}$ : $-dI_{E}/dt = 20 \text{ A/us}$	-	4	11	nC
t <sub>rr</sub>	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	20	25	ns
	-	-dI <sub>F</sub> /dt = 100 A/μs				
I <sub>rrm</sub>	Peak reverse recovery current	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	1.0	2	Α
		$I - dI_F / dt = 50 \text{ A/} \mu \text{s}; T_i = 100 °C$				
$V_{fr}$	Forward recovery voltage	$-dI_F/dt = 50 \text{ A/}\mu\text{s}; T_j = 100 \text{ °C}$ $I_F = 1 \text{ A}; dI_F/dt = 10 \text{ A/}\mu\text{s}$	-	1	-	V

# Rectifier diodes ultrafast, rugged

# BYQ30EX series



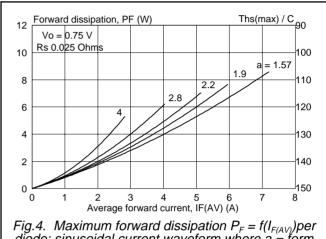
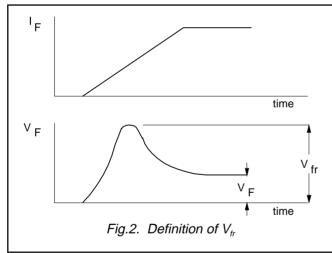
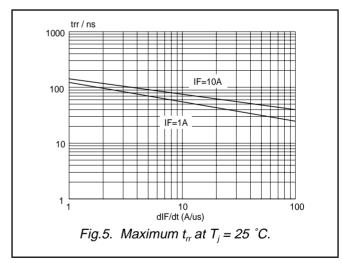
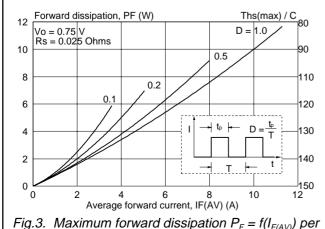
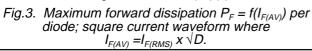


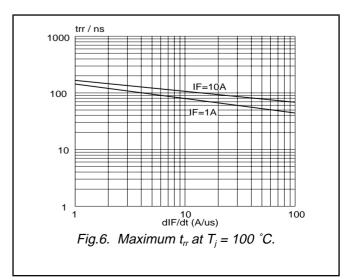
Fig.4. Maximum forward dissipation  $P_F = f(I_{F(AV)})$  per diode; sinusoidal current waveform where a = f orm f actor  $= I_{F(RMS)} / I_{F(AV)}$ .





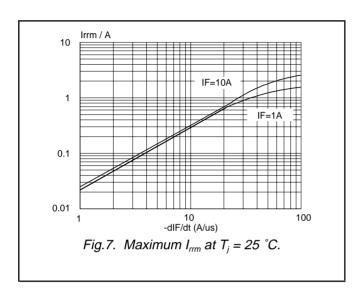


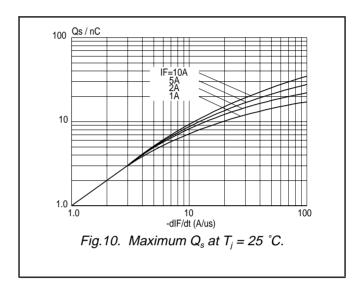


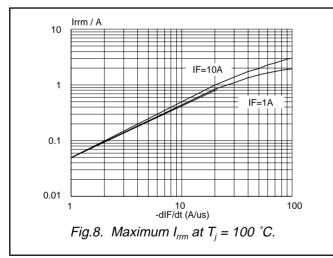


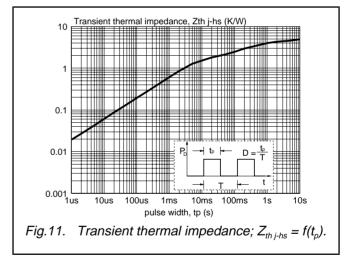
# Rectifier diodes ultrafast, rugged

# BYQ30EX series









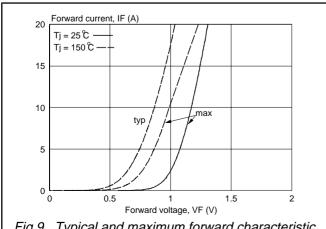
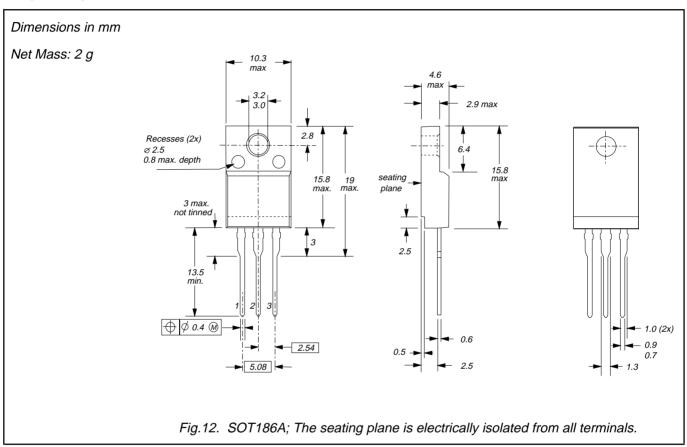


Fig.9. Typical and maximum forward characteristic  $I_F = f(V_F)$ ; parameter  $T_j$ 

Rectifier diodes ultrafast, rugged BYQ30EX series

## **MECHANICAL DATA**



- Refer to mounting instructions for F-pack envelopes.
   Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Rectifier diodes ultrafast, rugged

BYQ30EX series

#### **DEFINITIONS**

Data sheet status				
Objective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification This data sheet contains preliminary data; supplementary data may be published late				
Product specification This data sheet contains final product specifications.				
I the Marian and the same				

#### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

Where application information is given, it is advisory and does not form part of the specification.

## © Philips Electronics N.V. 1998

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.